3.3V 32-1250Mbps AnyRate™ CLOCK AND DATA RECOVERY

FEATURES

- Industrial temperature range (-40°C to +85°C)
- 3.3V power supply
- Clock and data recovery from 32Mbps up to 1.25Gbps NRZ data stream, clock generation from 32Mbps to 1.25Gbps
- Complies with Bellcore, ITU/CCITT and ANSI specifications for applications such as OC-1, OC-3, OC-12, ATM, FDDI, Fibre Channel and Gigabit Ethernet as well as proprietary applications
- Two on-chip PLLs: one for clock generation and another for clock recovery
- Selectable reference frequencies
- Differential PECL high-speed serial I/O
- Line receiver input: No external buffering needed
- **■** Link fault indication
- 100K ECL compatible I/O
- Available in 32-pin EPAD-TQFP and 28-pin SOIC packages

DESCRIPTION

The SY87701L is a complete Clock Recovery and Data Retiming integrated circuit for data rates from 32Mbps up to 1.25Gbps NRZ. The device is ideally suited for SONET/SDH/ATM and Fibre Channel applications and other high-speed data transmission systems.

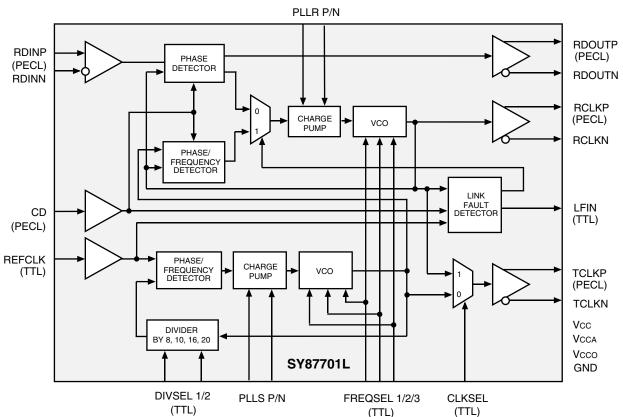
Clock recovery and data retiming is performed by synchronizing the on-chip VCO directly to the incoming data stream. The VCO center frequency is controlled by the reference clock frequency and the selected divide ratio. On-chip clock generation is performed through the use of a frequency multiplier PLL with a byte rate source as reference.

The SY87701L also includes a link fault detection circuit.

APPLICATIONS

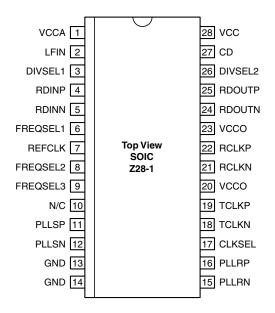
- SONET/SDH/ATM OC-1, OC-3, OC-12, OC-24
- **■** Fibre Channel, Escon, SMPTE 259
- Gigabit Ethernet/Fast Ethernet
- Proprietary architecture up to 1.25Gbps

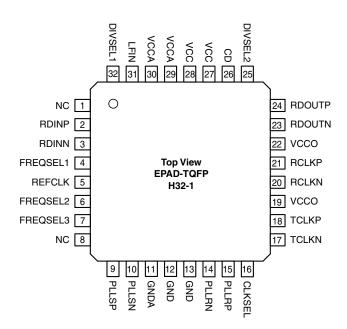
BLOCK DIAGRAM



AnyRate is a trademark of Micrel, Inc.

PIN CONFIGURATION





PIN DESCRIPTIONS

INPUTS

RDINP, RDINN [Serial Data Input] Differential PECL.

These built-in line receiver inputs are connected to the differential receive serial data stream. An internal receive PLL recovers the embedded clock (RCLK) and data (RDOUT) information. The incoming data rate can be within one of eight frequency ranges depending on the state of the FREQSEL pins. See "Frequency Selection" Table.

REFCLK [Reference Clock] TTL input.

This input is used as the reference for the internal frequency synthesizer and the "training" frequency for the receiver PLL to keep it centered in the absence of data coming in on the RDIN inputs.

CD [Carrier Detect] PECL Input.

This input controls the recovery function of the Receive PLL and can be driven by the carrier detect output of optical modules or from external transition detection circuitry. When this input is HIGH the input data stream (RDIN) is recovered normally by the Receive PLL. When this input is LOW the data on the inputs RDIN will be internally forced to a constant LOW, the data outputs RDOUT will remain LOW, the Link Fault Indicator output LFIN forced LOW and the clock recovery PLL forced to lock onto the clock frequency generated from REFCLK.

FREQSEL1, ..., FREQSEL3 [Frequency Select] TTL Inputs

These inputs select the output clock frequency range as shown in the "Frequency Selection" Table.

DIVSEL1, DIVSEL2 [Divider Select] TTL Inputs.

These inputs select the ratio between the output clock frequency (RCLK/TCLK) and the REFCLK input frequency as shown in the "Reference Frequency Selection" Table.

CLKSEL [Clock Select] TTL Input.

This input is used to select either the recovered clock of the receiver PLL (CLKSEL = HIGH) or the clock of the frequency synthesizer (CLKSEL = LOW) to the TCLK outputs.

OUTPUTS

LFIN [Link Fault Indicator] TTL Output.

This output indicates the status of the input data stream RDIN. Active HIGH signal is indicating when the internal clock recovery PLL has locked onto the incoming data stream. LFIN will go HIGH if CD is HIGH and RDIN is within the frequency range of the Receive PLL (1000ppm). LFIN is an asynchronous output.

RDOUTP, RDOUTN [Receive Data Output] Differential PFCI

These ECL 100K outputs represent the recovered data from the input data stream (RDIN). This recovered data is specified against the rising edge of RCLK.

RCLKP, RCLKN [Clock Output] Differential PECL.

These ECL 100K outputs represent the recovered clock used to sample the recovered data (RDOUT).

TCLKP, TCLKN [Clock Output] Differential PECL.

These ECL 100K outputs represent either the recovered clock (CLKSEL = HIGH) used to sample the recovered data (RDOUT) or the transmit clock of the frequency synthesizer (CLKSEL = LOW).

PLLSP, PLLSN [Clock Synthesis PLL Loop Filter]

External loop filter pins for the clock synthesis PLL.

PLLRP, PLLRN [Clock Recovery PLL Loop Filter] External loop filter pins for the receiver PLL.

POWER & GROUND

Vcc Supply Voltage(1)

VCCA Analog Supply Voltage⁽¹⁾
VCCO Output Supply Voltage⁽¹⁾

GND Ground NC No Connect

NOTE:

1. Vcc, Vcca, Vcco must be the same value.

FUNCTIONAL DESCRIPTION

Clock Recovery

Clock Recovery, as shown in the block diagram generates a clock that is at the same frequency as the incoming data bit rate at the Serial Data input. The clock is phase aligned by a PLL so that it samples the data in the center of the data eye pattern.

The phase relationship between the edge transitions of the data and those of the generated clock are compared by a phase/frequency detector. Output pulses from the detector indicate the required direction of phase correction. These pulses are smoothed by an integral loop filter. The output of the loop filter controls the frequency of the Voltage Controlled Oscillator (VCO), which generates the recovered clock.

Frequency stability without incoming data is guaranteed by an alternate reference input (REFCLK) that the PLL locks onto when data is lost. If the Frequency of the incoming signal varies by greater than approximately 1000ppm with respect to the synthesizer frequency, the PLL will be declared out of lock, and the PLL will lock to the reference clock.

The loop filter transfer function is optimized to enable the PLL to track the jitter, yet tolerate the minimum transition density expected in a received SONET data signal. This transfer function yields a 30µs data stream of continuous 1's or 0's for random incoming NRZ data.

The total loop dynamics of the clock recovery PLL provides jitter tolerance which is better than the specified tolerance in GR-253-CORE.

Lock Detect

The SY87701L contains a link fault indication circuit which monitors the integrity of the serial data inputs. If the received serial data fails the frequency test, the PLL will be forced to lock to the local reference clock. This will maintain the correct frequency of the recovered clock output under loss of signal or loss of lock conditions. If the recovered clock frequency deviates from the local reference clock frequency by more than approximately 1000ppm, the PLL will be declared out of lock. The lock detect circuit will poll the input data stream in an attempt to reacquire lock to data. If the recovered clock frequency is determined to be within approximately 1000ppm, the PLL will be declared in lock and the lock detect output will go active.

CHARACTERISTICS

Performance

The SY87701L PLL complies with the jitter specifications proposed for SONET/SDH equipment defined by the Bellcore Specifications: GR-253-CORE, Issue 2, December 1995 and ITU-T Recommendations: G.958 document, when used with differential inputs and outputs.

Input Jitter Tolerance

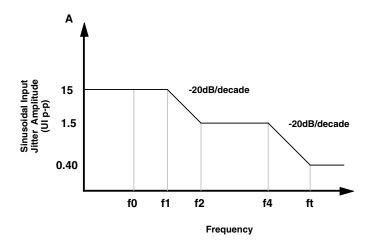
Input jitter tolerance is defined as the peak-to-peak amplitude of sinusoidal jitter applied on the input signal that causes an equivalent 1dB optical/electrical power penalty. SONET input jitter tolerance requirement condition is the input jitter amplitude which causes an equivalent of 1dB power penalty.

Jitter Transfer

Jitter transfer function is defined as the ratio of jitter on the output OC-N/STS-N signal to the jitter applied on the input OC-N/STS-N signal versus frequency. Jitter transfer requirements are shown in Figure 2.

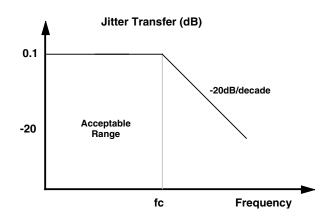
Jitter Generation

The jitter of the serial clock and serial data outputs shall not exceed .01 U.I. rms when a serial data input with no jitter is presented to the serial data inputs.



OC/STS-N Level	f0 (Hz)	f1 (Hz)	f2 (Hz)	f3 (kHz)	ft (kHz)
3	10	30	300	6.5	65
12	10	30	300	25	250

Figure 1. Input Jitter Tolerance



OC/STS-N Level	fc (kHz)	P (dB)
3	130	0.1
12	225	0.1

Figure 2. Jitter Transfer

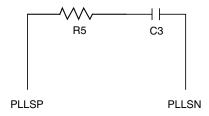
FREQUENCY SELECTION TABLE

FREQSEL1	FREQSEL2	FREQSEL3	fvco/frclk	frclк Data Rates (Mbps)
0	0	0	1	750 – 1250
0	0	1	2	375 – 625
0	1	0	4	188 – 313
0	1	1	6	125 – 208
1	0	0	8	94 – 157
1	0	1	12	63 – 104
1	1	0	16	47 – 78
1	1	1	24	32 – 52

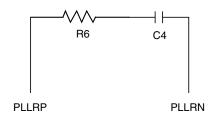
REFERENCE FREQUENCY SELECTION

DIVSEL1	DIVSEL2	frclk/frefclk
0	0	8
0	1	10
1	0	16
1	1	20

LOOP FILTER COMPONENTS(1)



 $\begin{array}{ll} \textbf{SONET} & \textbf{Wide Range} \\ \text{R5} = 80\Omega & \text{R5} = 350\Omega \\ \text{C3} = 1.5 \mu\text{F (X7R Dielectric)} & \text{C3} = 0.47 \mu\text{F (X7R Dielectric)} \end{array}$



 $\begin{array}{ll} \textbf{SONET} & \textbf{Wide Range} \\ \text{R6} = 50\Omega & \text{R6} = 680\Omega \\ \text{C4} = 1.0 \mu\text{F (X7R Dielectric)} & \text{C4} = 0.47 \mu\text{F (X7R Dielectric)} \\ \end{array}$

NOTE:

1. Suggested Values. Values may vary for different applications.

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Rating	Value	Unit
V _{CC}	Power Supply Voltage	-0.5 to +7.0	V
V _I	Input Voltage	–0.5 to V _{CC}	V
l _{оит}	Output Current - Continuor - Surge	us 50 100	mA
T _{store}	Storage Temperature	-65 to +150	°C
T _A	Operating Temperature	-40 to +85	°C

NOTE:

PACKAGE THERMAL DATA⁽¹⁾

 θ_{JA} (°C/W) by Velocity (LFPM)

Package	0	200	500
28-Pin SOIC	80	_	1
32-Pin EP-TQFP ⁽²⁾	27.6	22.6	20.7

NOTES:

- 1. Airflow of 500lfpm recommended for 28-pin SOIC.
- 2. Using JEDEC standard test boards with die attach pad soldered to PCB. See www.amkor.com for additional package details.

^{1.} Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to ABSOLUTE MAXIMUM RATING conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
V_{CC}	Power Supply Voltage	3.15	3.3	3.45	V	
I _{CC}	Power Supply Current	_	170	230	mA	

PECL 100K DC ELECTRICAL CHARACTERISTICS

 $V_{CC} = V_{CCO} = V_{CCA} = 3.3V \pm 5\%; T_A = -40^{\circ}C \text{ to } +85^{\circ}C$

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
V _{IH}	Input HIGH Voltage	V _{CC} –1.165	_	V _{CC} -0.880	V	
V_{IL}	Input LOW Voltage	V _{CC} –1.810	_	V _{CC} -1.475	V	
V _{OH}	Output HIGH Voltage	V _{CC} –1.075	_	V _{CC} -0.830	V	50Ω to V _{CC} –2V
V _{OL}	Output LOW Voltage	V _{CC} -1.860	_	V _{CC} -1.570	V	50Ω to V _{CC} –2V
I _{IL}	Input LOW Current	0.5	_	_	μΑ	$V_{IN} = V_{IL}(Min)$

TTL DC ELECTRICAL CHARACTERISTICS

 $V_{CC} = V_{CCO} = V_{CCA} = 3.3V \pm 5\%; T_A = -40^{\circ}C \text{ to } +85^{\circ}C$

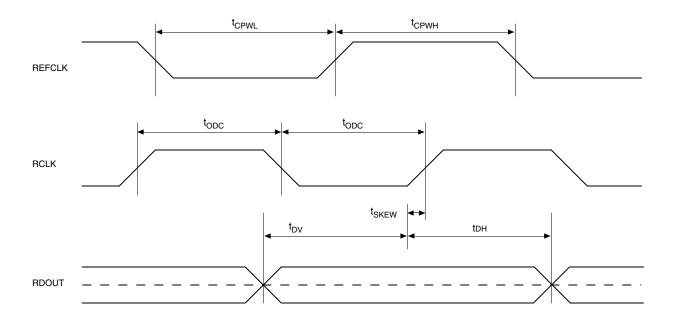
Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
V _{IH}	Input HIGH Voltage	2.0	_	V _{CC}	V	
V _{IL}	Input LOW Voltage	_	_	0.8	V	
V _{OH}	Output HIGH Voltage	2.0	_	_	V	I _{OH} = -0.4mA
V _{OL}	Output LOW Voltage	_	_	0.5	V	I _{OL} = 4mA
I _{IH}	Input HIGH Current	–175 —	-	— +100	μ Α μ Α	$V_{IN} = 2.7V$, $V_{CC} = Max$. $V_{IN} = V_{CC}$, $V_{CC} = Max$.
I _{IL}	Input LOW Current	-300	_	_	μΑ	$V_{IN} = 0.5V$, $V_{CC} = Max$.
Ios	Output Short Circuit Current	15	_	100	mA	V _{OUT} = 0V (maximum 1sec)

AC ELECTRICAL CHARACTERISTICS

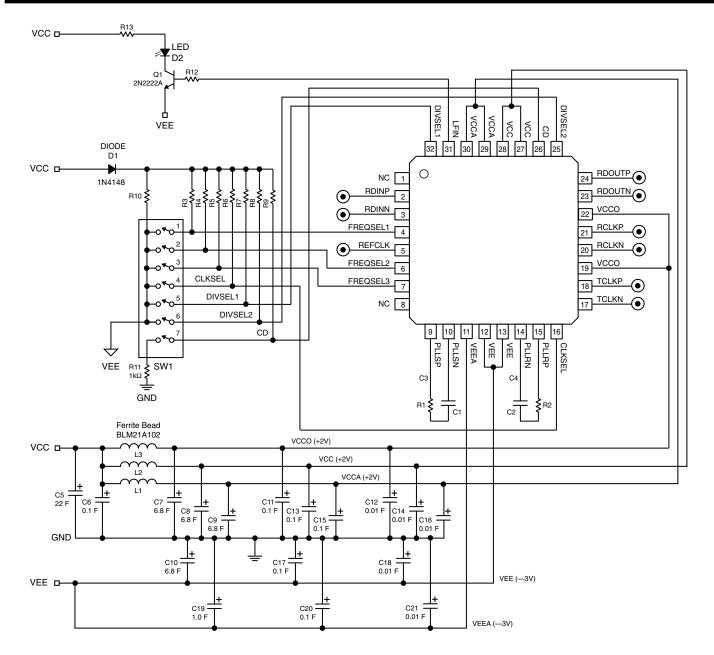
 $V_{CC} = V_{CCO} = V_{CCA} = 3.3V \pm 5\%; T_A = -40^{\circ}C \text{ to } +85^{\circ}C$

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
f _{VCO}	VCO Center Frequency	750	1	1250	MHz	f _{REFCLK} * Byte Rate
Δf_{VCO}	VCO Center Frequency Tolerance	_	5	_	%	Nominal
t _{ACQ}	Acquisition Lock Time	_	1	15	μs	
t _{CPWH}	REFCLK Pulse Width HIGH	4		_	ns	
t _{CPWL}	REFCLK Pulse Width LOW	4		_	ns	
t _{ir}	REFCLK Input Rise Time		0.5	2	ns	
t _{ODC}	Output Duty Cycle (RCLK/TCLK)	45		55	% of UI	
t _r t _f	ECL Output Rise/Fall Time (20% to 80%)	100		500	ps	50 Ω to V _{CC} –2
t _{skew}	Recovered Clock Skew	-200	1	+200	ps	
t _{DV}	Data Valid	1/(2*f _{RCLK}) - 200	_	_	ps	
t _{DH}	Data Hold	1/(2*f _{RCLK}) - 200	_	_	ps	

TIMING WAVEFORMS



32-PIN APPLICATION EXAMPLE

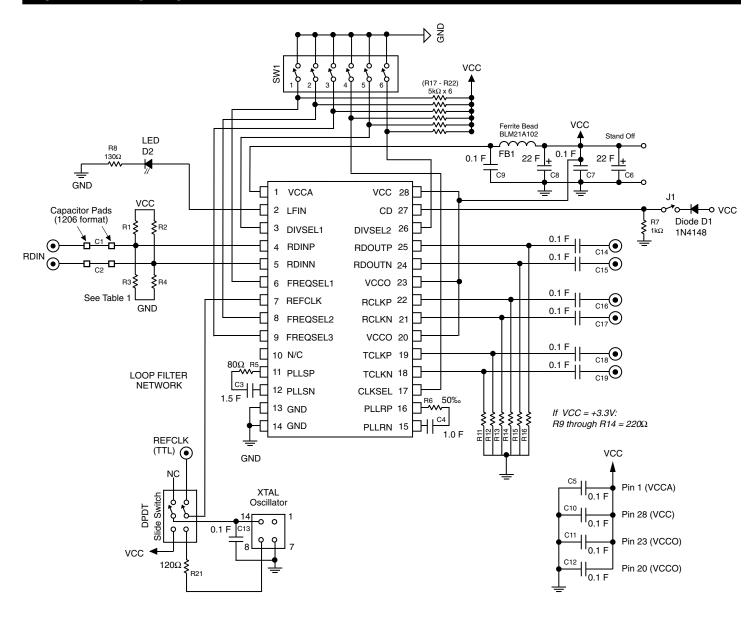


Note:

C3, C4 are optional

$C1 = C2 = 0.47 \mu F$	
$R1 = 820\Omega$	
$R2 = 1.2k\Omega$	
R3 through R10 = $5k\Omega$	
$R12 = 12k\Omega$	
$R13 = 130\Omega$	

28-PIN APPLICATION EXAMPLE



For AC coupling only	For DC mode only		
C1 = C2 = 0.1µF	C1 = C2 = Shorted		
$R1 = R2 = 680\Omega$	$R1 = R2 = 130\Omega$		
R3 = R4 = 1kΩ	R3 = R4 = 82Ω		

Table 1.

Note

1. C5 and C10–C12 are decoupling capacitors and should be kept as close to the power pins as possible.

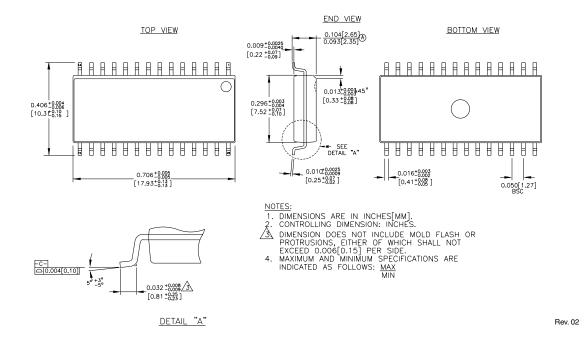
BILL OF MATERIALS (32-PIN EPAD-TQFP)

Item	Part Number	Manufacturer	Description	Qty.
C1, C2	ECU-V1H104KBW	Panasonic	0.47μF Ceramic Capacitor, Size 1206 X7R Dielectric, Loop Filter, Critical	2
C3, C4	ECU-V1H104KBW	Panasonic	0.47μF Ceramic Capacitor, Size 1206 2 X7R Dielectric, Loop Filter, Optional	
C5	ECS-T1ED226R	Panasonic	22μF Tantalum Electrolytic Capacitor, Size D 1	
C6	ECU-V1H104KBW	Panasonic	0.1µF Ceramic Capacitor, Size 1206 1 X7R Dielectric, Power Supply Decoupling	
C7, C8, C9, C10	ECS-T1EC685R	Panasonic	6.8µF Tantalum Electrolytic Capacitor, Size C 4	
C19	ECJ-3YB1E105K	Panasonic	1.0µF Ceramic Capacitor, Size 1206 1 X7R Dielectric, VEEA Decoupling	
C11, C13	ECU-V1H104KBW	Panasonic	0.1µF Ceramic Capacitor, Size 1206 1 X7R Dielectric, VCCO/VCC Decoupling	
C15, C17	ECU-V1H104KBW	Panasonic	0.1μF Ceramic Capacitor, Size 1206 1 X7R Dielectric, VCCA/VEEA Decoupling	
C20	ECU-V1H104KBW	Panasonic	0.1μF Ceramic Capacitor, Size 1206 1 X7R Dielectric, VEEA Decoupling	
C12, C14	ECU-V1H103KBW	Panasonic	0.01μF Ceramic Capacitor, Size 1206 1 X7R Dielectric, VCCO/VCC Decoupling	
C16, C18	ECU-V1H103KBW	Panasonic	0.01μF Ceramic Capacitor, Size 1206 1 X7R Dielectric, VCCA/VEEA Decoupling	
C21	ECU-V1H103KBW	Panasonic	0.01μF Ceramic Capacitor, Size 1206 1 X7R Dielectric, VEEA Decoupling	
D1	1N4148		Diode 1	
D2	P300-ND/P301-ND	Panasonic	T-1 3/4 Red LED 1	
J1, J2, J3, J4, J5 J6, J7, J8, J9, J10, J11, J12	142-0701-851	Johnson Components	Gold Plated, Jack, SMA, PCB Mount 12	
L1, L2, L3	BLM21A102F	Murata	Ferrite Beads, Power Noise Suppression	
Q1	NTE123A	NTE	2N2222A Buffer/Driver Transistor, NPN	1
R1			820Ω Resistor, 2%, Size 1206 Loop Filter Component, Critical	1
R2			1.2kΩ Resistor, 2%, Size 1206 Loop Filter Component, Critical	1
R3, R4, R5, R6 R7, R8, R9, R10			5kΩ Pullup Resistors, 2%, Size 1206	8
R11			1kΩ Pulldown Resistor, 2%, Size 1206	1
R12			12kΩ Resistor, 2%, Size 1206	1
R13			130Ω Pullup Resistor, 2%, Size 1206	1
SW1	206-7	CTS	SPST, Gold Finish, Sealed Dip Switch	1

PRODUCT ORDERING CODE

Ordering Code	Package Type	Operating Range
SY87701LZI	Z28-1	Industrial
SY87701LHI	H32-1	Industrial

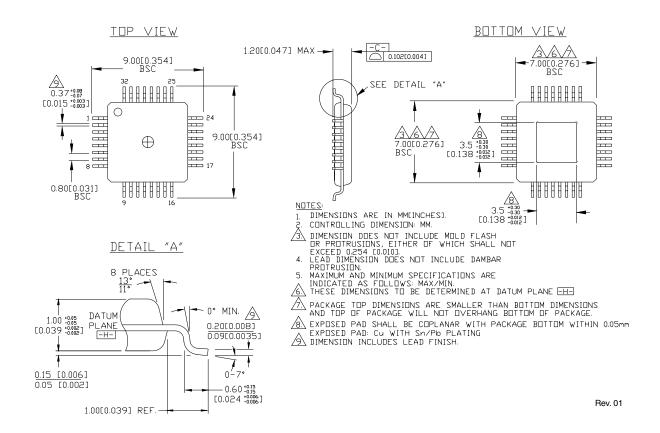
28 LEAD SOIC .300" WIDE (Z28-1)

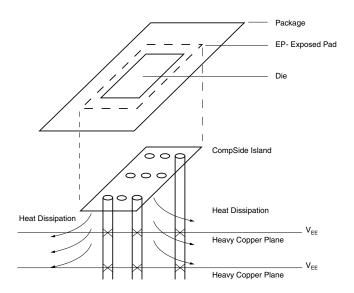


Note:

The 28 Lead SOIC package is NOT recommended for new designs.

32 LEAD EPAD TQFP (DIE UP) (H32-1)





PCB Thermal Consideration for 32-Pin EPAD-TQFP Package

APPENDIX A

Layout and General Suggestions

- 1. Establish controlled impedance stripline, microstrip, or co-planar construction techniques.
- 2. Signal paths should have, approximately, the same width as the device pads.
- 3. All differential paths are critical timing paths, where skew should be matched to within ± 10 ps.
- 4. Signal trace impedance should not vary more than ±5%. If in doubt, perform TDR analysis of all high-speed signal traces.
- 5. Maintain compact filter networks as close to filter pins as possible. Provide ground plane relief under filter path to reduce stray capacitance. Be careful of crosstalk coupling into the filter network.
- 6. Maintain low jitter on the REFCLK input. Isolate the XTAL oscillator from power supply noise by adequately decoupling. Keep XTAL oscillator close to device, and minimize capacitive coupling from adjacent signals.
- 7. Higher speed operation may require use of fundamental-tone (third-overtone typically have more jitter) crystal based oscillator for optimum performance. Evaluate and compare candidates by measuring TXCLK jitter.
- 8. Evaluate ASIC AND FPGA REFIN source clocks with suitable jitter analysis equipment, such as TDS11801 tektronix DSO oscilloscope, or Wavecrest DTS2077 Time Interval Analyzer.
- 9. All unused outputs require termination.

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